

*In order to comply with environmental legislation C.I.F, the manufacturer of this photo-resist PCB, has since December 2006 produced the PCB with a new type of photo-resist.*

*This photo-resist is now light blue in appearance compared to the original dark blue colour.*

*The photo-resist is applied more thickly to the copper layer than the original resist.*

*It may sometimes have a striped appearance owing to the way it is applied.*

*When properly exposed and developed this will not affect the finished PCB.*

*The exposure time with the new board is longer than with the old.*

*Typical exposure time with a totally opaque track layout on a clear transparency could now be as much as 2mins 30 sec.*

*With non-opaque tracks tests should be carried out to determine a satisfactory time*

*The developer temperature should be between 18 deg C and 27 deg C.*

*CIF only recommend the use of their own developer. Either sachet RS 160-9490 or ready-to-use RS 160-9513.*

Mike Field 26/11/2007